



SSC80211GN4

P-Channel Enhancement Mode MOSFET

➤ Features

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	I _D
-20V	±12V	5.5mΩ@-4V5	-60A
		7.5mΩ@-2V5	

➤ Description

This SSC80211GN4 uses advanced trench technology to provide excellent RDSON and low gate charge. The complementary MOSFETS may be used to form a level shifted high side switch, and for a host of other applications.

100% UIS + ΔVDS + Rg Tested!

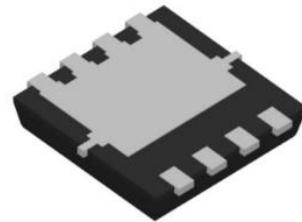
➤ Applications

- Load Switch
- PWM Application
- Power Management

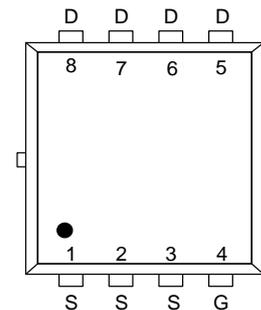
➤ Ordering Information

Device	Package	Shipping
SSC80211GN4	PDFN3.3X3.3-8L	5000/Reel

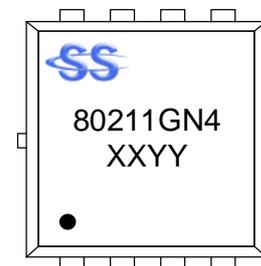
➤ Pin configuration



PDFN3.3X3.3-8L (Bottom View)



Pin Configuration (Top View)



Marking

(XXYY: Internal Traceability Code)



➤ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V_{DSS}	Drain-to-Source Voltage	-20	V
V_{GSS}	Gate-to-Source Voltage	± 12	V
I_D	Continuous Drain Current ^d	$T_C=25^\circ\text{C}$	-60
		$T_C=100^\circ\text{C}$	-32
I_{DSM}	Continuous Drain Current ^a	$T_A=25^\circ\text{C}$	-19
		$T_A=70^\circ\text{C}$	-13.4
I_{DM}	Pulsed Drain Current ^b	-240	A
P_D	Power Dissipation ^c	$T_C=25^\circ\text{C}$	31.2
		$T_C=100^\circ\text{C}$	12.5
P_{DSM}	Power Dissipation ^a	$T_A=25^\circ\text{C}$	3.13
		$T_A=70^\circ\text{C}$	2
E_{AS}	Avalanche Energy ^b L=0.5mH Single Pulse	156	mJ
T_J	Operation junction temperature	-55~150	°C
T_{STG}	Storage temperature range	-55~150	

➤ Thermal Resistance Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance ^a	40	°C/W
$R_{\theta JC}$	Junction-to-Case Thermal Resistance	4	

Note:

- The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user is specific board design. The power dissipation is based on the $t \leq 10\text{s}$ thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation P_D is based on $T_{J(MAX)}=150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- The maximum current rating is package limited.

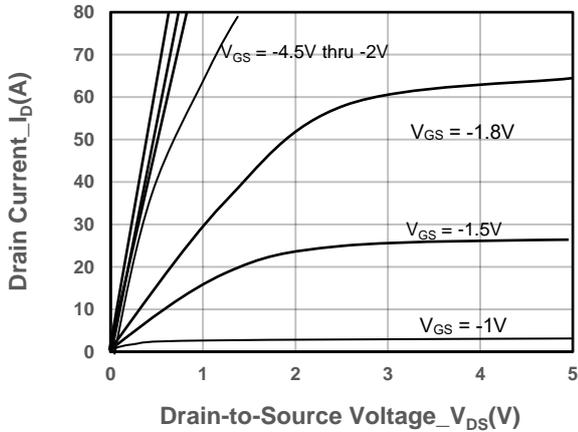


➤ **Electrical Characteristics (T_A=25°C unless otherwise noted)**

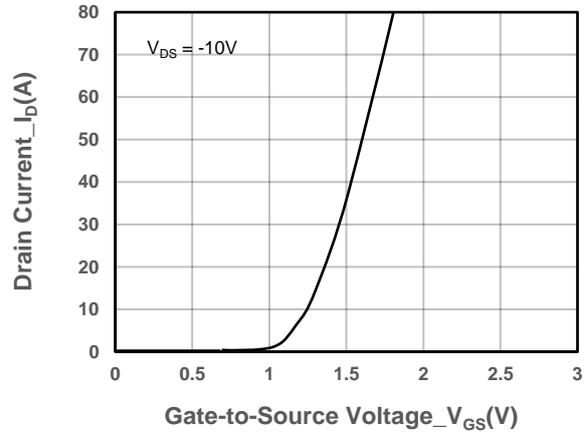
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.4	-0.8	-1.2	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = -4.5V, I _D = -15A		5.5	7.5	mΩ
		V _{GS} = -2.5V, I _D = -10A		7.5	10	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20V, V _{GS} = 0V			-1	μA
Gate-Source Leak Current	I _{GSS}	V _{GS} = ±12V, V _{DS} = 0V			±100	nA
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = -5A			-1.2	V
Gate Resistance	R _G	V _{DS} = 0V, f = 1MHz		8.6		Ω
Input Capacitance	C _{ISS}	V _{DS} = -10V, V _{GS} = 0V, f = 1MHz		5280		pF
Output Capacitance	C _{OSS}			480		
Reverse Transfer Capacitance	C _{RSS}			376		
Total Gate Charge	Q _G	V _{GS} = -4.5V, V _{DS} = -10V, I _D = -15A		56		nC
Gate to Source Charge	Q _{GS}			8		
Gate to Drain Charge	Q _{GD}			15		
Turn-on Delay Time	T _{D(ON)}	V _{GS} = -10V, V _{DD} = -10V, I _D = -15A, R _G = 2.7Ω		11		ns
Rise Time	T _r			108		
Turn-off Delay Time	T _{D(OFF)}			142		
Fall Time	T _f			150		



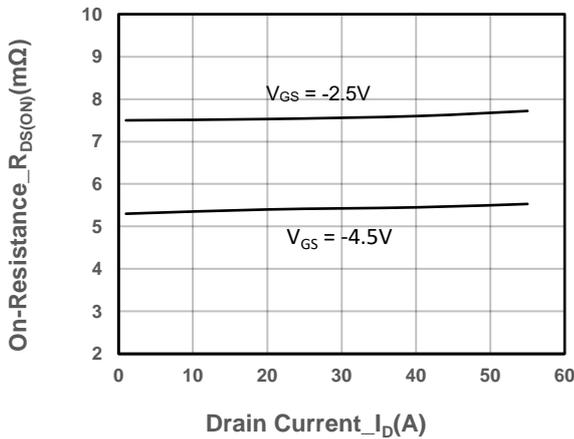
➤ **Typical Performance Characteristics (T_A=25°C unless otherwise noted)**



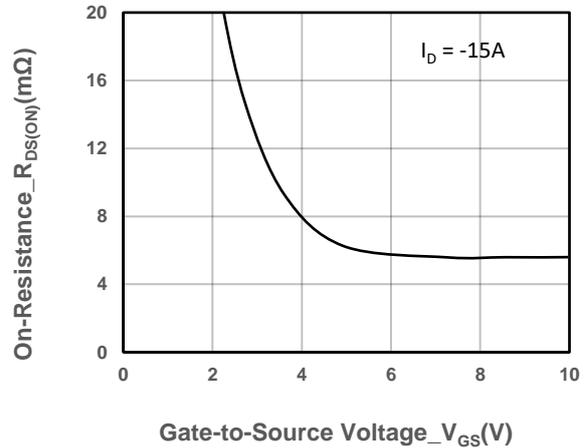
Output Characteristics



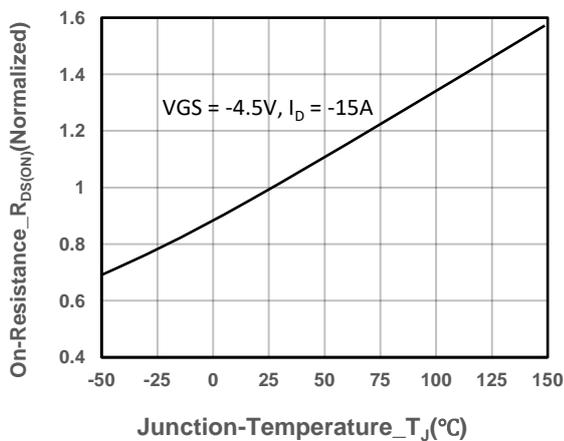
Transfer Characteristics



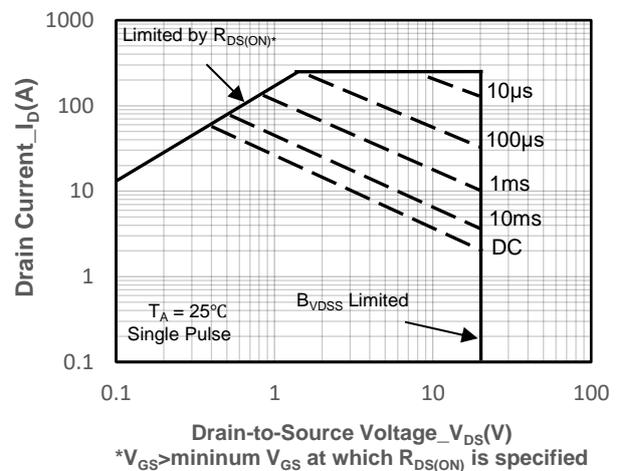
On-Resistance vs. Drain Current and Gate Voltage



On-Resistance vs. Gate-to-Source Voltage



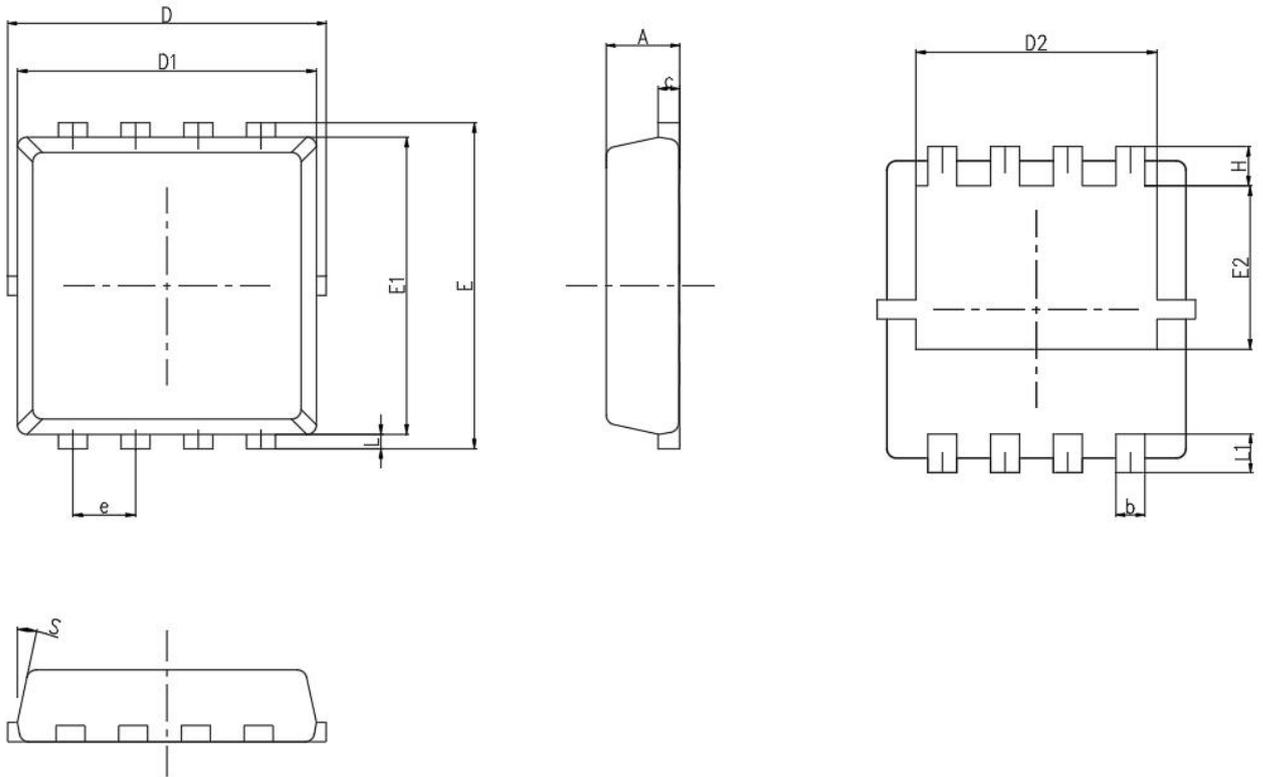
On-Resistance vs. Junction Temperature



Safe Operating Area vs. Junction-to-Ambient



➤ Package Information



Symbol	MILL IMETER		
	Min	Nom	Max
A	0.65	0.75	0.9
b	0.20	0.3	0.40
c	0.1	/	0.22
D	3.1	3.3	3.45
D1	3	3.15	3.2
D2	2.55	2.5	2.75
E	3.15	3.3	3.45
E1	2.9	3.05	3.2
E2	1.55	1.75	1.95
e	0.65BSC		
L	0.06	0.15	0.2
L1	0.25	0.4	0.55
H	0.31	0.35	0.6
S	10°	12°	14°



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